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## Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	63
Number of Logic Elements/Cells	504
Total RAM Bits	-
Number of I/O	68
Number of Gates	6000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	84-LCC (J-Lead)
Supplier Device Package	84-PLCC (29.31x29.31)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf8636alc84-4

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## ...and More Features

- Peripheral register for fast setup and clock-to-output delay
- Fabricated on an advanced SRAM process
- Available in a variety of packages with 84 to 304 pins (see Table 2)
- Software design support and automatic place-and-route provided by the Altera® MAX+PLUS® II development system for Windows-based PCs, as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

#### Note:

(1) FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad

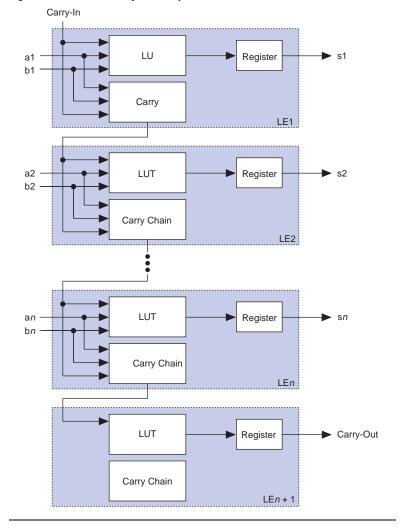


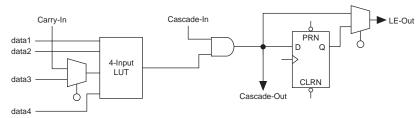
Figure 4. FLEX 8000 Carry Chain Operation

### Cascade Chain

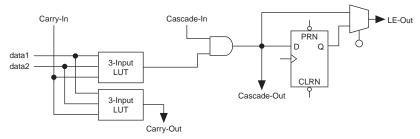
With the cascade chain, the FLEX 8000 architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.6 ns per LE.

Figure 6. FLEX 8000 LE Operating Modes

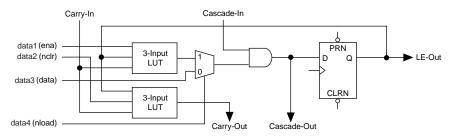
### **Normal Mode**



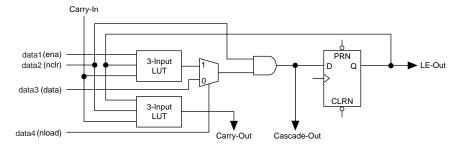
### **Arithmetic Mode**



## **Up/Down Counter Mode**



## **Clearable Counter Mode**



Each LE in an LAB can drive up to two separate column interconnect channels. Therefore, all 16 available column channels can be driven by the LAB. The column channels run vertically across the entire device, and share access to LABs in the same column but in different rows. The MAX+PLUS II Compiler chooses which LEs must be connected to a column channel. A row interconnect channel can be fed by the output of the LE or by two column channels. These three signals feed a multiplexer that connects to a specific row channel. Each LE is connected to one 3-to-1 multiplexer. In an LAB, the multiplexers provide all 16 column channels with access to 8 row channels.

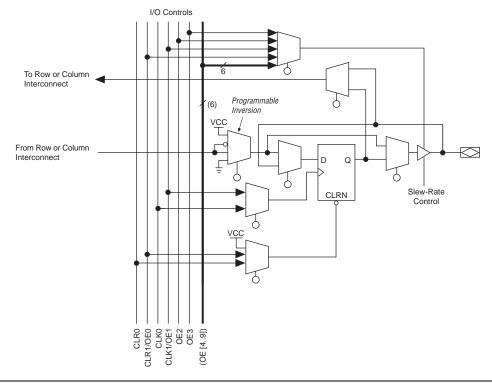
Each column of LABs has a dedicated column interconnect that routes signals out of the LABs into the column. The column interconnect can then drive I/O pins or feed into the row interconnect to route the signals to other LABs in the device. A signal from the column interconnect, which can be either the output of an LE or an input from an I/O pin, must transfer to the row interconnect before it can enter an LAB. Table 4 summarizes the FastTrack Interconnect resources available in each FLEX 8000 device.

Table 4. FLE	Table 4. FLEX 8000 FastTrack Interconnect Resources									
Device	Rows	Channels per Row	Columns	Channels per Column						
EPF8282A EPF8282AV	2	168	13	16						
EPF8452A	2	168	21	16						
EPF8636A	3	168	21	16						
EPF8820A	4	168	21	16						
EPF81188A	6	168	21	16						
EPF81500A	6	216	27	16						

Figure 9 shows the interconnection of four adjacent LABs, with row, column, and local interconnects, as well as the associated cascade and carry chains.

## Figure 10. FLEX 8000 IOE

Numbers in parentheses are for EPF81500A devices only.



## Row-to-IOE Connections

Figure 11 illustrates the connection between row interconnect channels and IOEs. An input signal from an IOE can drive two separate row channels. When an IOE is used as an output, the signal is driven by an *n*-to-1 multiplexer that selects the row channels. The size of the multiplexer varies with the number of columns in a device. EPF81500A devices use a 27-to-1 multiplexer; EPF81188A, EPF8820A, EPF8636A, and EPF8452A devices use a 21-to-1 multiplexer; and EPF8282A and EPF8282AV devices use a 13-to-1 multiplexer. Eight IOEs are connected to each side of the row channels.

Table 5 lists the source of the peripheral control signal for each FLEX 8000 device by row.

Peripheral Control Signal	EPF8282A EPF8282AV	EPF8452A	EPF8636A	EPF8820A	EPF81188A	EPF81500A
CLK0	Row A	Row A	Row A	Row A	Row E	Row E
CLK1/OE1	Row B	Row B	Row C	Row C	Row B	Row B
CLR0	Row A	Row A	Row B	Row B	Row F	Row F
CLR1/OE0	Row B	Row B	Row C	Row D	Row C	Row C
OE2	Row A	Row A	Row A	Row A	Row D	Row A
OE3	Row B	Row B	Row B	Row B	Row A	Row A
OE4	_	_	-	_	-	Row B
OE5	_	_	-	_	-	Row C
OE6	-	-	-	-	-	Row D
OE7	-	-	-	-	-	Row D
OE8	-	-	-	-	-	Row E
OE9	_	_	-	_	-	Row F

## Output Configuration

This section discusses slew-rate control and MultiVolt I/O interface operation for FLEX 8000 devices.

## **Slew-Rate Control**

The output buffer in each IOE has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slow slew rate reduces system noise by slowing signal transitions, adding a maximum delay of 3.5 ns. The slow slew-rate setting affects only the falling edge of a signal. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate on a pin-by-pin basis during design entry or assign a default slew rate to all pins on a global basis.



For more information on high-speed system design, go to *Application Note 75 (High-Speed Board Designs)*.

## MultiVolt I/O Interface

The FLEX 8000 device architecture supports the MultiVolt I/O interface feature, which allows EPF81500A, EPF81188A, EPF8820A, and EPF8636A devices to interface with systems with differing supply voltages. These devices in all packages—except for EPF8636A devices in 84-pin PLCC packages—can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of  $V_{\rm CC}$  pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 5.0-V power supply. With a 5.0-V  $V_{\rm CCINT}$  level, input voltages are at TTL levels and are therefore compatible with 3.3-V and 5.0-V inputs.

The VCCIO pins can be connected to either a 3.3-V or 5.0-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 5.0-V power supply, the output levels are compatible with 5.0-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with  $V_{\rm CCIO}$  levels lower than 4.75 V incur a nominally greater timing delay of  $t_{\rm OD2}$  instead of  $t_{\rm OD1}$ . See Table 8 on page 26.

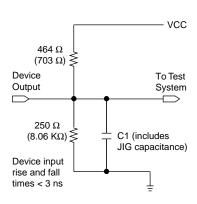
## IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

The EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices provide JTAG BST circuitry. FLEX 8000 devices with JTAG circuitry support the JTAG instructions shown in Table 6.

Table 6. EPF8282A,	Table 6. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Instructions							
JTAG Instruction	Description							
SAMPLE/PRELOAD	Allows a snapshot of the signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern to be output at the device pins.							
EXTEST	Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.							
BYPASS	Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through the selected device to adjacent devices during normal device operation.							

## Figure 15. FLEX 8000 AC Test Conditions

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-groundcurrent transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in parentheses are for 3.3-V devices or outputs. Numbers without parentheses are for 5.0-V devices or outputs.

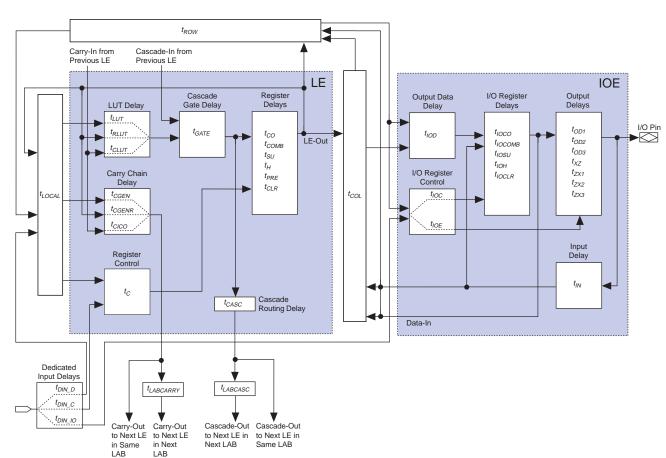


## Operating Conditions

Tables 9 through 12 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 5.0-V FLEX 8000 devices.

Table 9	Table 9. FLEX 8000 5.0-V Device Absolute Maximum Ratings       Note (1)								
Symbol	Parameter	Conditions	Min	Max	Unit				
V <sub>CC</sub>	Supply voltage	With respect to ground (2)	-2.0	7.0	V				
V <sub>I</sub>	DC input voltage		-2.0	7.0	V				
I <sub>OUT</sub>	DC output current, per pin		-25	25	mA				
T <sub>STG</sub>	Storage temperature	No bias	-65	150	° C				
$T_{AMB}$	Ambient temperature	Under bias	-65	135	° C				
$T_J$	Junction temperature	Ceramic packages, under bias		150	° C				
		PQFP and RQFP, under bias		135	° C				

Figure 19. FLEX 8000 Timing Model



Symbol		Speed Grade								
	А	-2	A	-3	A	-4				
	Min	Max	Min	Max	Min	Max				
$t_{IOD}$		0.7		0.8		0.9	ns			
t <sub>IOC</sub>		1.7		1.8		1.9	ns			
t <sub>IOE</sub>		1.7		1.8		1.9	ns			
t <sub>IOCO</sub>		1.0		1.0		1.0	ns			
t <sub>IOCOMB</sub>		0.3		0.2		0.1	ns			
$t_{IOSU}$	1.4		1.6		1.8		ns			
$t_{IOH}$	0.0		0.0		0.0		ns			
$t_{IOCLR}$		1.2		1.2		1.2	ns			
$t_{IN}$		1.5		1.6		1.7	ns			
$t_{OD1}$		1.1		1.4		1.7	ns			
$t_{OD2}$		-		-		-	ns			
$t_{OD3}$		4.6		4.9		5.2	ns			
$t_{XZ}$		1.4		1.6		1.8	ns			
$t_{ZX1}$		1.4		1.6		1.8	ns			
$t_{ZX2}$		-		-		-	ns			
$t_{ZX3}$		4.9		5.1		5.3	ns			

Symbol			Speed	Grade			Unit
	A	-2	А	-3	A-	-4	
	Min	Max	Min	Max	Min	Max	
t <sub>LABCASC</sub>		0.3		0.4		0.4	ns
t <sub>LABCARRY</sub>		0.3		0.4		0.4	ns
t <sub>LOCAL</sub>		0.5		0.5		0.7	ns
t <sub>ROW</sub>		5.0		5.0		5.0	ns
$t_{COL}$		3.0		3.0		3.0	ns
t <sub>DIN_C</sub>		5.0		5.0		5.5	ns
t <sub>DIN_D</sub>		7.0		7.0		7.5	ns
t <sub>DIN IO</sub>		5.0		5.0		5.5	ns

Table 34. EPF8636A I/O Element Timing Parameters								
Symbol	Speed Grade							
	A-2		A	A-3		<b>1-4</b>	1	
	Min	Max	Min	Max	Min	Max		
$t_{IOD}$		0.7		0.8		0.9	ns	
t <sub>IOC</sub>		1.7		1.8		1.9	ns	
t <sub>IOE</sub>		1.7		1.8		1.9	ns	
t <sub>IOCO</sub>		1.0		1.0		1.0	ns	
t <sub>IOCOMB</sub>		0.3		0.2		0.1	ns	
t <sub>IOSU</sub>	1.4		1.6		1.8		ns	
t <sub>IOH</sub>	0.0		0.0		0.0		ns	
t <sub>IOCLR</sub>		1.2		1.2		1.2	ns	
t <sub>IN</sub>		1.5		1.6		1.7	ns	
t <sub>OD1</sub>		1.1		1.4		1.7	ns	
t <sub>OD2</sub>		1.6		1.9		2.2	ns	
t <sub>OD3</sub>		4.6		4.9		5.2	ns	
$t_{XZ}$		1.4		1.6		1.8	ns	
$t_{ZX1}$		1.4		1.6		1.8	ns	
$t_{ZX2}$		1.9		2.1		2.3	ns	
$t_{ZX3}$		4.9		5.1		5.3	ns	

Symbol		Speed Grade							
	A	-2	A	1-3	A	-4			
	Min	Max	Min	Max	Min	Max	-		
t <sub>LABCASC</sub>		0.3		0.4		0.4	ns		
t <sub>LABCARRY</sub>		0.3		0.4		0.4	ns		
t <sub>LOCAL</sub>		0.5		0.5		0.7	ns		
t <sub>ROW</sub>		5.0		5.0		5.0	ns		
$t_{COL}$		3.0		3.0		3.0	ns		
t <sub>DIN_C</sub>		5.0		5.0		5.5	ns		
t <sub>DIN_D</sub>		7.0		7.0		7.5	ns		
t <sub>DIN IO</sub>		5.0		5.0		5.5	ns		

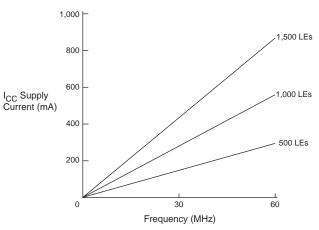
Table 36. EPF8636A LE Timing Parameters								
Symbol	Speed Grade							
	A-2		A-3		A-4			
	Min	Max	Min	Max	Min	Max		
$t_{LUT}$		2.0		2.3		3.0	ns	
$t_{CLUT}$		0.0		0.2		0.1	ns	
t <sub>RLUT</sub>		0.9		1.6		1.6	ns	
t <sub>GATE</sub>		0.0		0.0		0.0	ns	
t <sub>CASC</sub>		0.6		0.7		0.9	ns	
t <sub>CICO</sub>		0.4		0.5		0.6	ns	
t <sub>CGEN</sub>		0.4		0.9		0.8	ns	
t <sub>CGENR</sub>		0.9		1.4		1.5	ns	
$t_{C}$		1.6		1.8		2.4	ns	
t <sub>CH</sub>	4.0		4.0		4.0		ns	
t <sub>CL</sub>	4.0		4.0		4.0		ns	
$t_{CO}$		0.4		0.5		0.6	ns	
t <sub>COMB</sub>		0.4		0.5		0.6	ns	
t <sub>SU</sub>	0.8		1.0		1.1		ns	
t <sub>H</sub>	0.9		1.1		1.4		ns	
t <sub>PRE</sub>		0.6		0.7		0.8	ns	
t <sub>CLR</sub>		0.6		0.7		0.8	ns	

Table 37. EPF8636A	External Timing	g Parameters					
Symbol			Speed G	rade			Unit
	A	-2	А	-3	А	-4	
	Min	Max	Min	Max	Min	Max	1
t <sub>DRR</sub>		16.0		20.0		25.0	ns
t <sub>ODH</sub>	1.0		1.0		1.0		ns

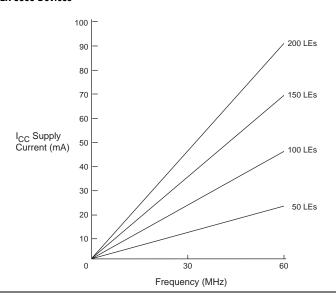
Symbol	Speed Grade								
	A	A-2		A-3		A-4			
	Min	Max	Min	Max	Min	Max			
$t_{IOD}$		0.7		0.8		0.9	ns		
t <sub>IOC</sub>		1.7		1.8		1.9	ns		
$t_{IOE}$		1.7		1.8		1.9	ns		
t <sub>IOCO</sub>		1.0		1.0		1.0	ns		
t <sub>IOCOMB</sub>		0.3		0.2		0.1	ns		
t <sub>IOSU</sub>	1.4		1.6		1.8		ns		
t <sub>IOH</sub>	0.0		0.0		0.0		ns		
t <sub>IOCLR</sub>		1.2		1.2		1.2	ns		
t <sub>IN</sub>		1.5		1.6		1.7	ns		
t <sub>OD1</sub>		1.1		1.4		1.7	ns		
t <sub>OD2</sub>		1.6		1.9		2.2	ns		
t <sub>OD3</sub>		4.6		4.9		5.2	ns		
$t_{XZ}$		1.4		1.6		1.8	ns		
$t_{ZX1}$		1.4		1.6		1.8	ns		
$t_{ZX2}$		1.9		2.1		2.3	ns		
$t_{ZX3}$		4.9		5.1		5.3	ns		

Symbol	Speed Grade							
	A-2		A-3		A-4		1	
	Min	Max	Min	Max	Min	Max	1	
t <sub>LABCASC</sub>		0.3		0.3		0.4	ns	
t <sub>LABCARRY</sub>		0.3		0.3		0.4	ns	
t <sub>LOCAL</sub>		0.5		0.6		0.8	ns	
$t_{ROW}$		6.2		6.2		6.2	ns	
t <sub>COL</sub>		3.0		3.0		3.0	ns	
t <sub>DIN_C</sub>		5.0		5.0		5.5	ns	
t <sub>DIN_D</sub>		8.2		8.2		8.7	ns	
t <sub>DIN IO</sub>		5.0		5.0		5.5	ns	

Figure 20. FLEX 8000 I<sub>CCACTIVE</sub> vs. Operating Frequency 5.0-V FLEX 8000 Devices



#### 3.3-V FLEX 8000 Devices



# Configuration & Operation

The FLEX 8000 architecture supports several configuration schemes to load a design into the device(s) on the circuit board. This section summarizes the device operating modes and available device configuration schemes.



For more information, go to *Application Note 33 (Configuring FLEX 8000 Devices)* and *Application Note 38 (Configuring Multiple FLEX 8000 Devices)*.

Pin Name	84-Pin	84-Pin	100-Pin	100-Pin	144-Pin	160-Pin	160-Pin
	PLCC EPF8282A	PLCC EPF8452A EPF8636A	TQFP EPF8282A EPF8282AV	TQFP EPF8452A	TQFP EPF8820A	PGA EPF8452A	PQFP EPF8820A (1)
ADD0	78	76	78	77	106	N3	6
DATA7	3	2	90	89	131	P8	140
DATA6	4	4	91	91	132	P10	139
DATA5	6	6	92	95	133	R12	138
DATA4	7	7	95	96	134	R13	136
DATA3	8	8	97	97	135	P13	135
DATA2	9	9	99	98	137	R14	133
DATA1	13	13	4	4	138	N15	132
DATA0	14	14	5	5	140	K13	129
SDOUT (3)	79	78	79	79	23	P4	97
TDI (4)	55	45 (5)	54	_	96	_	17
TDO (4)	27	27 (5)	18	_	18	_	102
TCK (4), (6)	72	44 (5)	72	_	88	_	27
TMS (4)	20	43 (5)	11	_	86	_	29
TRST (7)	52	52 (8)	50	_	71	_	45
Dedicated	12, 31, 54,	12, 31, 54,	3, 23, 53, 73	3, 24, 53,	9, 26, 82,	C3, D14,	14, 33, 94,
Inputs (10)	73	73		74	99	N2, R15	113
VCCINT	17, 38, 59, 80	17, 38, 59, 80	6, 20, 37, 56, 70, 87	9, 32, 49, 59, 82	8, 28, 70, 90, 111	B2, C4, D3, D8, D12, G3, G12, H4, H13, J3, J12, M4, M7, M9, M13, N12	3, 24, 46, 92, 114, 160
VCCIO	-	_	_	_	16, 40, 60, 69, 91, 112, 122, 141	_	23, 47, 57, 69, 79, 104, 127, 137, 149, 159

Table 52. FLE)	Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 3 of 3)									
Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A			
GND	5, 26, 47, 68	5, 26, 47, 68	2, 13, 30, 44, 52, 63, 80, 94	19, 44, 69, 94	7, 17, 27, 39, 54, 80, 81, 100,101, 128, 142	C12, D4, D7, D9, D13, G4, G13, H3, H12, J4, J13, L1, M3, M8, M12, M15, N4	12, 13, 34, 35, 51, 63, 75, 80, 83, 93, 103, 115, 126, 131, 143, 155			
No Connect (N.C.)	_	_	_	2, 6, 13, 30, 37, 42, 43, 50, 52, 56, 63, 80, 87, 92, 93, 99	_	_	_			
Total User I/O Pins (9)	64	64	74	64	108	116	116			

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A <i>(1)</i>
nSP (2)	120	1	R15	207	207	5
MSELO (2)	117	3	T15	4	4	21
MSEL1 (2)	84	38	Т3	49	49	33
nSTATUS (2)	37	83	B3	108	108	124
nCONFIG (2)	40	81	C3	103	103	107
DCLK (2)	1	120	C15	158	158	154
CONF_DONE (2)	4	118	B15	153	153	138
nWS	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	Т8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A (1)
DATA4	154	127	E17	165	172	170
DATA3	157	124	G15	162	171	168
DATA2	159	122	F15	160	167	166
DATA1	11	115	E16	149	165	163
DATA0	12	113	C16	147	162	161
SDOUT (3)	128	152	C7 (11)	198	124	119
TDI (4)	_	55	R11	72	20	-
TDO (4)	_	95	B9	120	129	-
TCK (4), (6)	_	57	U8	74	30	-
TMS (4)	_	59	U7	76	32	_
TRST (7)	_	40	R3	54	54	_
Dedicated Inputs (10)	5, 36, 85, 116	6, 35, 87, 116	A5, U5, U13, A13	7, 45, 112, 150	17, 36, 121, 140	13, 41, 116, 146
VCCINT (5.0 V)	21, 41, 53, 67, 80, 81, 100, 121, 133, 147, 160	4, 5, 26, 85, 106	C8, C9, C10, R8, R9, R10, R14	5, 6, 33, 110, 137	5, 6, 27, 48, 119, 141	4, 20, 35, 48, 50, 102, 114, 131, 147
VCCIO (5.0 V or 3.3 V)	_	25, 41, 60, 70, 80, 107, 121, 140, 149, 160	D3, D4, D9, D14, D15, G4, G14, L4, L14, P4, P9, P14	32, 55, 78, 91, 102, 138, 159, 182, 193, 206	26, 55, 69, 87, 102, 131, 159, 173, 191, 206	3, 19, 34, 49, 69, 87, 106, 123, 140, 156, 174, 192
GND	13, 14, 28, 46, 60, 75, 93, 107, 108, 126, 140, 155	15, 16, 36, 37, 45, 51, 75, 84, 86, 96, 97, 117, 126, 131, 154	C4, D7, D8, D10, D11, H4, H14, K4, K14, P7, P8, P10, P11	19, 20, 46, 47, 60, 67, 96, 109, 111, 124, 125, 151, 164, 171, 200	15, 16, 37, 38, 60, 78, 96, 109, 110, 120, 130, 142, 152, 164, 182, 200	11, 12, 27, 28, 42, 43, 60, 78, 96, 105, 115, 122, 132, 139, 148, 155, 159, 165, 183, 201
No Connect (N.C.)	2, 3, 38, 39, 70, 82, 83, 118, 119, 148	2, 39, 82, 119	C6, C12, C13, C14, E3, E15, F3, J3, J4, J14, J15, N3, N15, P3, P15, R4 (12)	1, 2, 3, 16, 17, 18, 25, 26, 27, 34, 35, 36, 50, 51, 52, 53, 104, 105, 106, 107, 121, 122, 123, 130, 131, 132, 139, 140, 141, 154, 155, 156, 157, 208	1, 2, 3, 50, 51, 52, 53, 104, 105, 106, 107, 154, 155, 156, 157, 208	1, 2, 51, 52, 53, 54, 103, 104, 157, 158, 207, 208
Total User I/O Pins (9)	116	114	132, 148 (13)	132	148	144

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
D3.003.4	A5	C7	198	194	W16	248
DATA4		D7	196	193	W17	246
DATA3	B5					
DATA2	E6	B5	194	190	V16	243
DATA1	D5	A3	191	189	U16	241
DATA0	C4	A2	189	187	V17	239
SDOUT (3)	K1	N2	135	136	F19	169
TDI	F15 (4)	_	_	63 (14)	B1 (14)	80 (14)
TDO	J2 (4)	-	_	117	C17	149
TCK (6)	J14 (4)	_	_	116 <i>(14)</i>	A19 (14)	148 (14)
TMS	J12 (4)	_	_	64 (14)	C2 (14)	81 (14)
TRST (7)	P14	_	_	115 <i>(14)</i>	A18 (14)	145 (14)
Dedicated Inputs	F4, L1, K12,	C1, C17, R1,	10, 51, 130,	8, 49, 131,	F1, F16, P3,	12, 64, 164,
(10)	E15	R17	171	172	P19	217
VCCINT	F5, F10, E1,	E4, H4, L4,	20, 42, 64, 66,	18, 40, 60, 62,	B17, D3, D15,	24, 54, 77,
(5.0 V)	L2, K4, M12, P15, H13, H14, B15, C13	P12, L14, H14, E14, R14, U1	114, 128, 150, 172, 236	91, 114, 129, 151, 173, 209, 236	E8, E10, E12, E14, R7, R9, R11, R13, R14, T14	144, 79, 115, 162, 191, 218, 266, 301
VCCIO (5.0 V or 3.3 V)	H3, H2, P6, R6, P10, N10, R14, N13, H15, H12, D12, A14, B10, A10, B6, C6, A2, C3, M4, R2	N10, M13, M5, K13, K5, H13, H5, F5, E10, E8, N8, F13	19, 41, 65, 81, 99, 116, 140, 162, 186, 202, 220, 235	17, 39, 61, 78, 94, 108, 130, 152, 174, 191, 205, 221, 235	D14, E7, E9, E11, E13, R6, R8, R10, R12, T13, T15	

#### Notes to tables:

- (1) Perform a complete thermal analysis before committing a design to this device package. See *Application Note 74* (Evaluating Power for Altera Devices) for more information.
- (2) This pin is a dedicated pin and is not available as a user I/O pin.
- (3) SDOUT will drive out during configuration. After configuration, it may be used as a user I/O pin. By default, the MAX+PLUS II software will not use SDOUT as a user I/O pin; the user can override the MAX+PLUS II software and use SDOUT as a user I/O pin.
- (4) If the device is not configured to use the JTAG BST circuitry, this pin is available as a user I/O pin.
- (5) JTAG pins are available for EPF8636A devices only. These pins are dedicated user I/O pins.
- (6) If this pin is used as an input in user mode, ensure that it does not toggle before or during configuration.
- (7) TRST is a dedicated input pin for JTAG use. This pin must be grounded if JTAG BST is not used.
- (8) Pin 52 is a V<sub>CC</sub> pin on EPF8452A devices only.
- (9) The user I/O pin count includes dedicated input pins and all I/O pins.
- (10) Unused dedicated inputs should be tied to ground on the board.
- (11) SDOUT does not exist in the EPF8636GC192 device.
- (12) These pins are no connect (N.C.) pins for EPF8636A devices only. They are user I/O pins in EPF8820A devices.
- (13) EPF8636A devices have 132 user I/O pins; EPF8820A devices have 148 user I/O pins.
- (14) For EPF81500A devices, these pins are dedicated JTAG pins and are not available as user I/O pins. If JTAG BST is not used, TDI, TCK, TMS, and TRST should be tied to GND.

## Revision History

The information contained in the *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 supersedes information published in previous versions. The *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 contains the following change: minor textual updates.